

Title (en)

CERAMIC HONEYCOMB STRUCTURE AND PROCESS FOR PRODUCING CERAMIC HONEYCOMB STRUCTURE

Title (de)

KERAMIKWABENSTRUKTUR UND VERFAHREN ZUR HERSTELLUNG EINER KERAMIKWABENSTRUKTUR

Title (fr)

STRUCTURE CÉRAMIQUE EN NID D'ABEILLE ET SON PROCÉDÉ DE FABRICATION

Publication

**EP 2070576 B1 20140319 (EN)**

Application

**EP 07828620 A 20070927**

Priority

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Abstract (en)

[origin: EP2070576A1] A ceramic honeycomb structure having porous cell walls defining large numbers of flow paths, the cell walls having porosity of 55-70%, an average pore diameter of 10-40  $\mu\text{m}$ , a concave area ratio CR (projected area ratio of portions lower than an average surface determined from cell wall surface roughness by a least square method) of 0.32-0.6, and an average concave depth H concave (average depth of portions lower than the average surface) of 0.02-0.1 mm.

IPC 8 full level

**C04B 35/195** (2006.01); **B01D 46/24** (2006.01); **F01N 3/022** (2006.01)

CPC (source: EP US)

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